

# IEEE 802.18 Radio Regulatory Technical Advisory Group

## Membership status as of 13 March 2026

### Summary

Voters	56
ExOfficio	10
Nearly Voters	10
Aspirants	24

### Voters

Last Name	First Name	Affiliation
Asai	Yusuke	NTT ASLabs
Au	Edward	Huawei Technologies Co., Ltd
Auluck	Vijay	Self
Beecher	Philip	Wi-SUN Alliance
Carney	William	Sony Corporation
da Silva	Claudio	MediaTek Inc.
de Vegt	Rolf	Qualcomm Incorporated
Desai	Prasanna	Intel Corporation
Emmelmann	Marc	Self
Fang	Yonggang	MediaTek Inc.
Gruber	Josef	Infineon Technologies
Hiertz	Guido	Ericsson GmbH
Holcomb	Jay	Self
Ikegami	Tetsushi	Meiji University
Jeffries	Timothy	FutureWei Technologies, Inc.
Ji	Chenhe	Huawei Technologies Co., Ltd.
Kain	Carl	USDOT, Noblis, Inc.
Kajita	Shugo	Space-Time Engineering Japan Inc.
Kato	Arata	Space-Time Engineering Japan, Inc.
Kenney	John	TOYOTA InfoTechnology Center U.S.A.
Kim	Youhan	Qualcomm Technologies Inc.
Kitazawa	Shoichi	Muroran Institute of Technology
Krebs	Alex	Apple
Krischer	Mark	Cisco
Lalam	Massinissa	Sagemcom Broadband SAS
Lansford	James	FaraFir Consulting
Levy	Joseph	InterDigital, Inc.
Li	Huan-Bang	National Institute of Information and Communications Technology (NICT)
Lynch	Michael	MJ Lynch & Associates, LLC.
Maman	Mickael	ST
Max	Sebastian	Ericsson AB

Last Name	First Name	Affiliation
Neiryneck	Dries	Ultra Radio Ltd
Nogami	Toshizo	Sharp Corporation
Patwardhan	Gaurav	Hewlett Packard Enterprise
Petrick	Al	Jones-Petrick Associates
Pettersson	Charlie	Ericsson AB
Pirhonen	Riku	NXP Semiconductors
Porat	Ron	Broadcom Corporation
Robert	Joerg	FAU Erlangen-Nuernberg/Fraunhofer IIS
Rolfe	Benjamin	Blind Creek Associates
Salem	Pelin	Cisco
Sand	Stephan	German Aerospace Center (DLR)
Schmidt	Reinhold	Infineon
Sherlock	Ian	Texas Instruments
Strickland	Stuart	Hewlett Packard Enterprise
Stuebing	Gary	Cisco Systems
Sumi	Takenori	Mitsubishi Electric Research Laboratories (MERL)
Takai	Mineo	Space-Time Engineering
Verso	Billy	Qorvo
Wang	Lei	FutureWei Technologies, Inc.
Ward	Lisa	Rohde & Schwarz
Wentink	Menzo	Qualcomm
Yaghoobi	Hassan	Apple
Yang	Shang-Te	Apple Inc.
Yu	Ross (Jian)	Huawei Technologies Co., Ltd
Zakaib	Larry	Spark Microsystems

### ExOfficio

Last Name	First Name	Affiliation
Baykas	Tuncer	Self
Bims	Harry	Bims Laboratories, Inc.
Gilb	James P.K.	General Atomics Aeronautical Systems and Gilb Consulting, UoSD, GenXCom
Godfrey	Tim	Electric Power Research Institute, Inc. (EPRI)
Halasz	Dave	Morse Micro
Marks	Roger	EthAirNet Associates and Huawei Technologies Co., Ltd.
Nikolich	Paul	Self
Powell	Clint	HID Global
Rosdahl	Jonathan	Qualcomm Technologies, Inc.
Stacey	Robert	Intel Corporation
Stanley	Dorothy	Hewlett Packard Enterprise

### Nearly voters

Last Name	First Name	Affiliation
Calvert	Chris	Landis+Gyr AG

Last Name	First Name	Affiliation
Guimond	Raphael	Spark Microsystems
Hsu	Yungping	MediaTek Inc.
Ishihara	Susumu	Shizuoka University
Jones	Vincent Knowles IV	Qualcomm Incorporated
Palm	kiwin (Stephen)	Broadcom Corporation
Portier	Fabrice	Silicon Labs
Sasaki	Shigenobu	Niigata University, Japan
Uno	Masanori	e-trees.Japan,inc

## Aspirants

Last Name	First Name	Affiliation
Almholt	Thomas	Texas Instruments
Blue	Scott	Space-Time Engineering Japan Inc.
Boldy	David	Broadcom Corporation
Carty	Clark	Hewlett Packard Enterprise
Helmy	Ahmed	Apple Inc.
Henry	Jerome	Cisco Systems, Inc.
Islim	Mohamed Sufyan	pureLiFi
Jang	Yeong Min	Kookmin University
Kim	Chan Woo	Cisco Systems
Kivinen	Tero	Self
Kohno	Ryuji	YNU/YRP-IAI
Kristem	Vinod	Apple
Kürner	Thomas	TU Braunschweig
Lin	Alfred	Sony Corporation
Mueller	Robert	BWI GmbH
Nabki	Fredrick	Spark Microsystems
Nagai	Yukimasa	Mitsubishi Electric Corporation
Otsuki	Shinya	NTT
Patel	Tushar	Teradyne, Inc.
Petranovich	James	ViaSat, Inc.
Qureshi	Haneya	General Motors Company
Wilhelmsson	Leif	Ericsson AB
Yong	Su Khiong	Apple Inc.
Zuniga	Juan Carlos	Cisco Systems